

深圳市金航标电子有限公司

SPECIFICATION

Ceramic Antenna 2012 Size

2400-2500 MHz

P/N: KH-2012-HM1



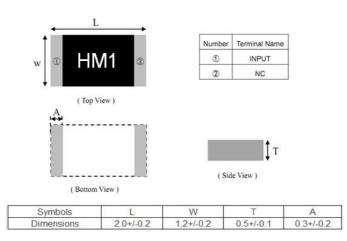
1. Frequency

2400-2500 MHz

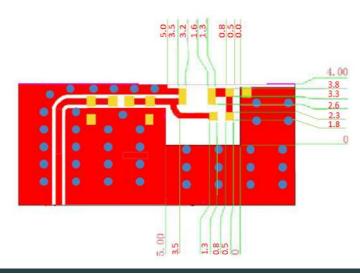
2. Applications

For Miniaturized Bluetooth System

- 3. Dimensions (Unit : mm)
 - 1). Over View :

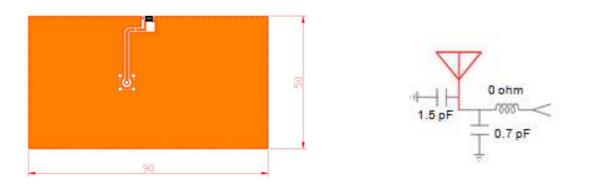


2). PCB Layout (Unit : mm) :





4. Evaluation Board Size and Matching Circuits

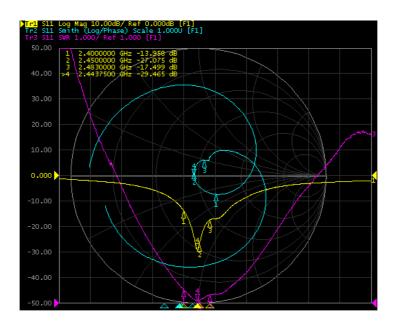


5. Electrical Characteristics

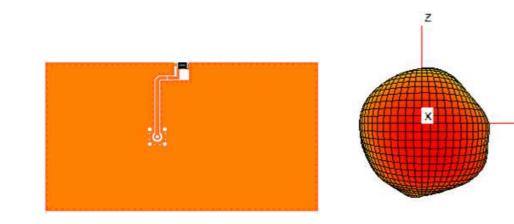
| Part Number | KH-2012-HM1 |
|-------------------|------------------|
| Central Frequency | 2450 MHz |
| Bandwidth | 100(typ.) MHz |
| V.S.W.R | ≤2.0 |
| Peak Gain | 3.12 dBi |
| Impedance | 50 Ohm |
| Polarization | Linear |
| Azimuth Beamwidth | Omni-directional |



6. Return Loss (S11)



7. Radiation Pattern & Efficiency



| Frequency (MHz) | 2400 | 2450 | 2500 |
|-----------------|-------|-------|-------|
| Efficiency (dB) | -2.22 | -1.87 | -2.08 |
| Efficiency (%) | 60 | 65 | 62 |
| Gain (dBi) | 2.75 | 3.12 | 3.01 |

-11

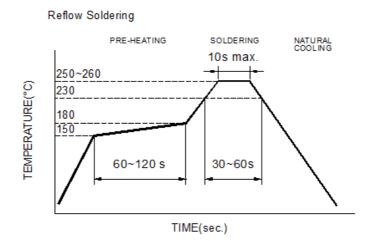
-23

-35

y

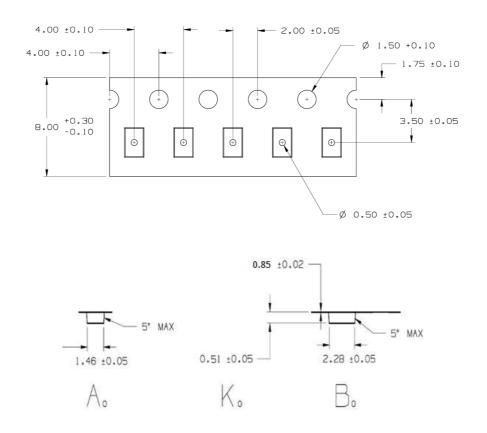


8. Reflow Soldering Standard Condition



9. Packaging and Dimensions

• Plastic Tape

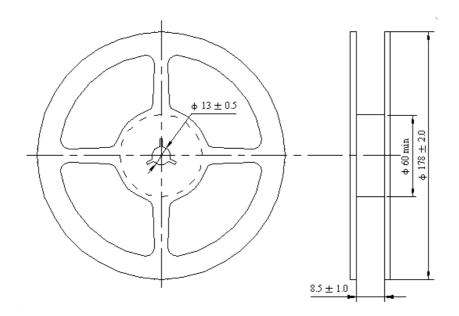




• Remarks for Package

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

• Reel (4000 pcs/Reel)



• Storage Period

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH



10. Dependability Test

| Test item | Test condition / Test method | Specification |
|---|--|---|
| Solderability IEC 60068-2-58 GB/T2423.28 | *Solder bath temperature : 240±5°C *Immersion time : 2±0.5 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free. | At least 95% of a surface of each terminal electrode must be covered by fresh solder. |
| Leaching (Resistance to dissolution of metallization) JIS C5101 | *Solder bath temperature : 260±5°C *Leaching immersion time : 10±1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free. | Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Resistance to soldering heat IEC 60068-2-58 GB/T2423.28 | *Preheating temperature : 120~150°C, 1 minute. *Solder temperature : 260±5°C *Immersion time : 10±1 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Drop Test IEC 60068-2-32 GB/T2423.8 Customer's specification. | *Height : 50 cm *Test Surface: Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |
| Vibration IEC 60068-2-6 GB/T 2423.10 | *Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions) | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |
| Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6 | *Pressurizing force : 5N(≦0603) ; 10N(>0603) *Test time:10±1 sec | No remarkable damage or removal of the termination. |



| Bending test IEC 60068-2-21 GB/T 2423.29 | The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |
|--|---|---|
| Temperature cycle IEC60068-2-14 GB/T 2423.22 | 30 minutes at-40°C±2°C. 10~15 minutes at room temperature. 30minutes at +85°C±2°C. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |
| High temperature IEC 60068-2-2 GB/T2423.2 | *Temperature : 85±2°C. *Test duration : 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics. |
| Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3 | *Humidity : 85±5%R.H. *Temperature : 85±2°C. *Time : 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 200hrs measuring the first data then 300hrs data. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |
| Low temperature IEC 60068-2-1 GB/T2423.1 | *Temperature : -40±2°C. *Test duration : 500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs. | No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. |